

HOSTAFORM®

POM copolymer injection molding grade with reduced emissions especially for automotive interior application. Burning rate according to FMVSS 302 < 100 mm/min (1 mm thickness) Emission according to VDA 275 < 1 mg/kg.

Product information			
Resin Identification Part Marking Code	POM >POM<		ISO 1043 ISO 11469
Rheological properties			
Melt volume-flow rate	8	cm ³ /10min	ISO 1133
Temperature	190		
Load	2.16	kg	
Typical mechanical properties			
Tensile modulus	2700	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min		MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	10		ISO 527-1/-2
Tensile strain at break, 50mm/min	30		ISO 527-1/-2
Flexural modulus	2650		ISO 178
Flexural stress at 3.5%		MPa kJ/m²	ISO 178 ISO 179/1eA
Charpy notched impact strength, 23°C Charpy notched impact strength, -30°C		kJ/m ²	ISO 179/1eA ISO 179/1eA
Poisson's ratio	0.38 ^[C]	NO/III	130 179/16A
[C]: Calculated	0.00		
-			
Thermal properties			
Melting temperature, 10°C/min	166		ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	100		ISO 75-1/-2
Coefficient of linear thermal expansion	129	E-6/K	ISO 11359-1/-2
(CLTE), parallel	101	F 0/1/	100 44050 4/0
Coefficient of linear thermal expansion (CLTE), normal	131	E-6/K	ISO 11359-1/-2
Flammability			
•	24.0	nama/main	ICO 2705 (FMVCC 202)
Burning rate, Thickness 2 mm	34.2	mm/min	ISO 3795 (FMVSS 302)
Physical/Other properties			
Humidity absorption, 2mm	0.2		Sim. to ISO 62
Water absorption, 2mm	0.65		Sim. to ISO 62
Density	1410	kg/m³	ISO 1183
Injection			
Drying Recommended	no		
Drying Temperature	100	°C	
Drying Time, Dehumidified Dryer	3 - 4		
Processing Moisture Content	≤0.2		
Melt Temperature Optimum	190		
Min. melt temperature	180	°C	

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Max. melt temperature	200	°C
Screw tangential speed	≤0.3	m/s
Mold Temperature Optimum	100	°C
Min. mould temperature	80	°C
Max. mould temperature	120	°C
Hold pressure range	60 - 120	MPa
Back pressure	4	MPa

Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent
Special characteristics Low emissions

Additional information

Injection molding Preprocessing

To achive low emission values pre drying using a recirculating air dryer (100 to $120 \, ^{\circ}\text{C}$ / max. 40 mm layer / 3 to 6 hours) is recommended.

Max. Water content 0,1 %

Processing

Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

Melt temperature 180-190 °C Mould temperature 60-120 °C

Postprocessing

Conditioning e.g. moisturizing is not necessary.

Processing Notes Pre-Drying

recommended

Automotive

OEM STANDARD ADDITIONAL INFORMATION

Li Auto Q/LiA5310020 2021 (V2)

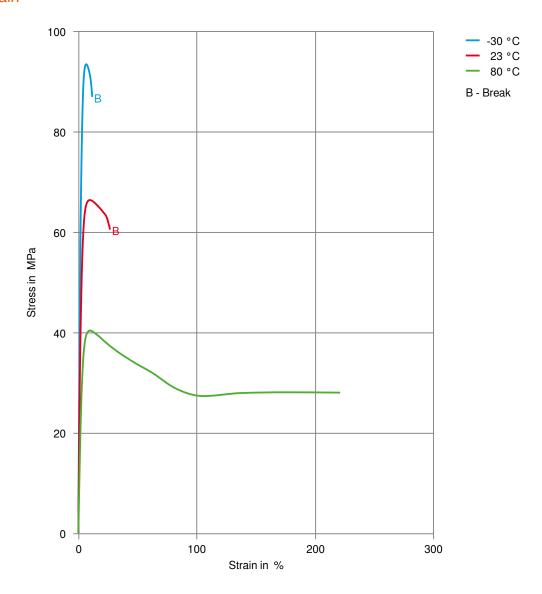
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Stress-strain

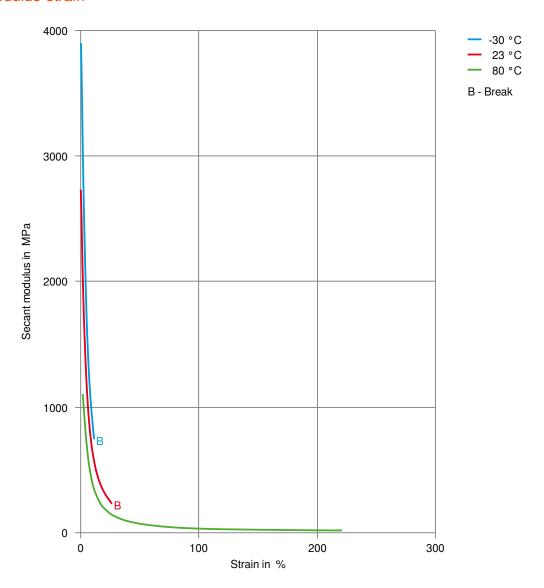


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Secant modulus-strain



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